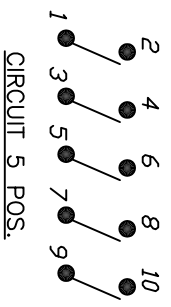
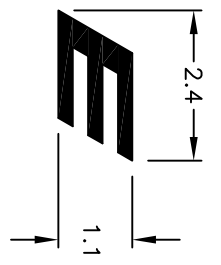
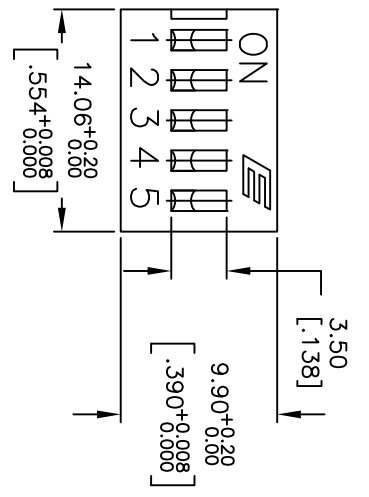


\* (Pos. 1 Denotes Pin No. 1)  
RECOMMEND P.C.B. LAYOUT

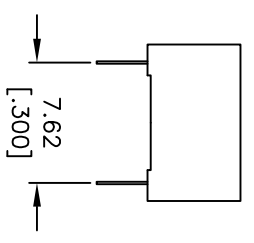
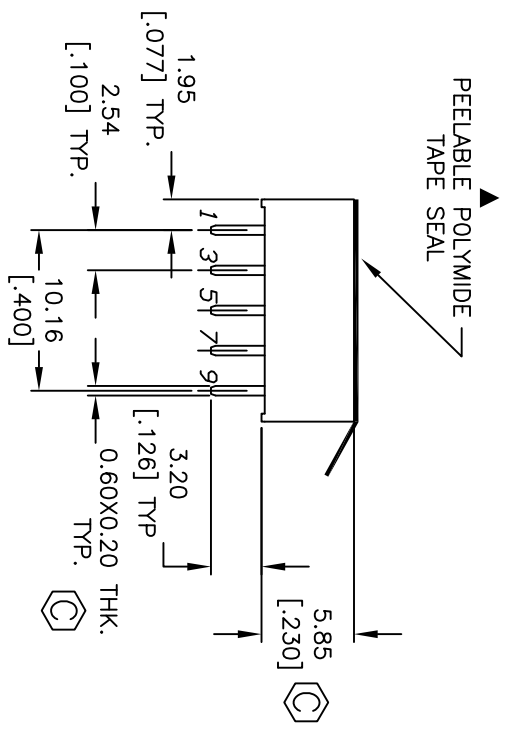


NOTES:

1. ALL DIMENSIONS IN MM [INCH]
2. GENERAL TOLERANCE: X.X=±0.4  
X.XX=±0.25
3. TERM. NOS. FOR REFERENCE ONLY.
4. CONTACT RATINGS: 25mA @24VDC. (Switch)  
100mA @50VDC. (Carry)
5. CONTACT MATERIAL:  
CONTACTS: (MOVABLE) GOLD PLATE  
TERMINALS: GOLD PLATE
6. INSULATION RESISTANCE:  
100 MEGA-OHMS MIN. @500VDC
7. CONTACT RESISTANCE:  
50 MILLI-OHMS TYPICAL @2-4VDC @100mA
8. OPERATING TEMP.:  
-40°C to +80°C
9. PACKAGE: IN DISPENSING TUBES  
WITH ALL POLES IN THE "OFF" POSITION.
10. TAPE SEAL FOR FLUX WASH.
11. ▲ DENOTES CRITICAL PARAMETER.



EXPLODED VIEW



B	21266	PCB STANDOFF, SMALL DIM CHANGES	10/10/13	EBP
A	13541	RELEASED FOR PRODUCTION	10/17/03	AR
REV.	ECN No.	DESCRIPTION	DATE	CHKD

TITLE		SCALE		DATE		DR		DWG		REV	
KAS1105RT		2:1		10/17/03		AR		N311051		B	



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